# **Specifications for Approval**

Customer Part No.:

Inhere Part No.: S2012CHRYGBT-001

Part Name: 2012 红黄绿蓝三色 LED

Spec Issue Date: 2018-07-13

Revision No.: A

To Customer:		
We submit herewith	the following information for yo	our approval:
Sample	□ OQC Inspection Record	LED Dimension
Electrical Chara	cteristics Curve	rnal Circuit Diagram
Soldering recon	nmendation	
Prepared by: Lily	Checked by: Tom	Approved by: Wangxiaojun
Date: 2018-07-13	Date: 2018-07-13	Date: 2018-07-13
Customer Opinion		

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- Approve and no objection
- Reject with the following reason:



东莞市银河光电有限公司 DongGuan Inhere Opto CO.,LTD. 地址:东莞市莞城科技园 D 幢 ADD:Guancheng Science & Technology Park, DongGuan TEL: 0769-23320868 FAX: 0769-23320878 E-mail: bill@inhereopto.com Http://www.inhereopto.com

## Features

2.0mm x 1.25mm SMD LED, 0.8mm thickness

Low power consumption

Wide view angle

Package: 3000pcs/reel

**RoHS** Compliant

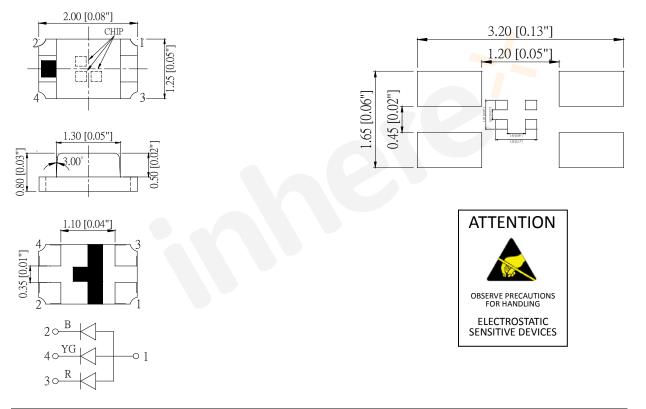
# Applications

Ideal for back light and indicator

Various colors and lens types available

## Package outlines

# **Recommend Pad Layout**



Part No.	Emitted color	Dice Material	Lens color
	Red	AlGaInP	
S2012CHRYGBT-001	Yellow Green	AlGaInP	Water transparent
	Blue	InGaN/GaN	

## Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are  $\pm 0.1$ mm (0.004inch) unless otherwise noted.

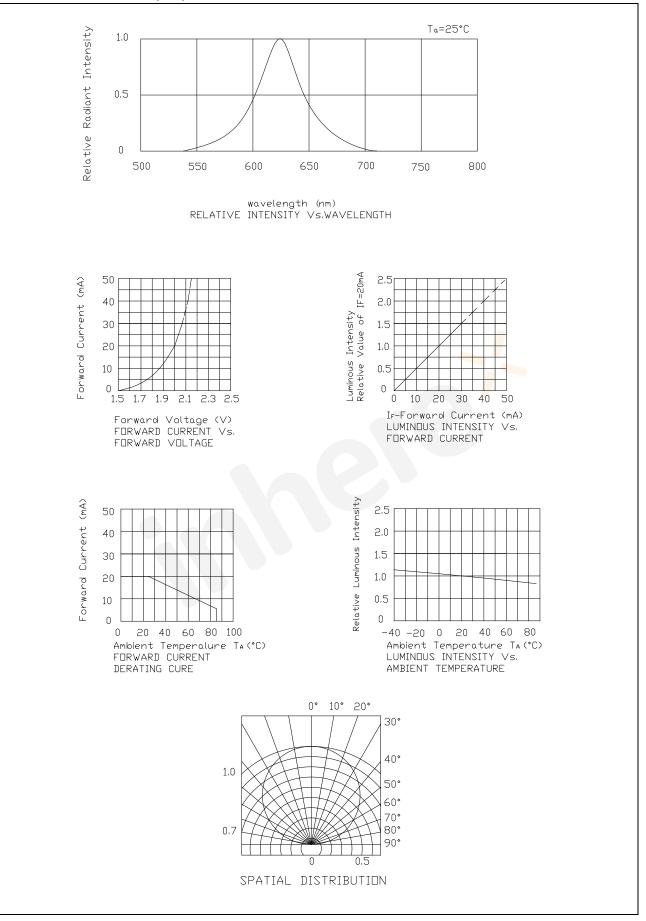
# Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Value			
Parameter		R	YG	В	Unit
Power dissipation	Pd	72	72	111	mW
Forward current	lf	30			mA
Reverse voltage	Vr	5			v
Operating temperature	Тор	-40 ~+80		0	°C
Storage temperature	Tstg	-40 ~+85		5	°C
Peak pulsing current (1/8 duty f=1kHz)	lfp		125		mA

# Electro-Optical Characteristics (Ta=25℃)

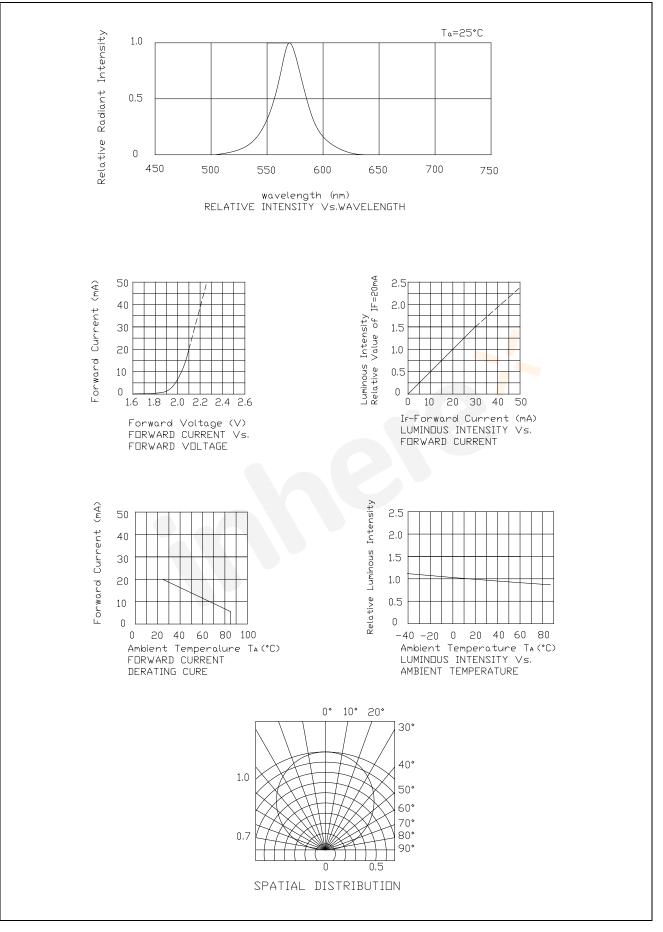
	Test	Symbol		Value			
Parameter	Condition			Min	Тур	Max	Unit
			R		633		
Wavelength at peak emission	lf=20mA	λp	YG		573		nm
			В		465		
			R		19		
Spectral half bandwidth	lf=20mA	$\bigtriangleup \lambda$	YG		18		nm
			В		25		
			R	620		630	
Dominant wavelength	lf=20mA	$\lambda$ d	YG	565		576	nm
			В	465		475	
			R	1.8		2.4	
Forward voltage	lf=20mA	Vf	YG	1.8		2.4	V
			В	2.8		3.7	
			R	100	180		
Luminous intensity	lf=20mA	lv	YG	25	40		mcd
			В	100	160		
Viewing angle at 50% Iv	lf=10mA	<b>2</b> θ1	/2		120		Deg
Reverse current	Vr=5V	lr				10	μΑ

#### **Optical Characteristic Curves (Red)**



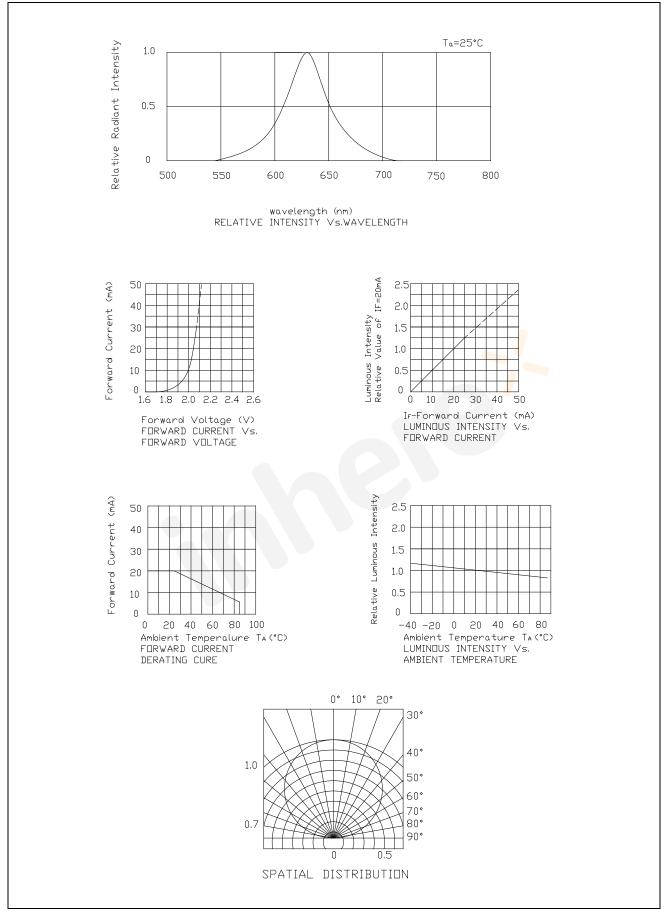
Part No.: S2012CHRYGBT-001 Prepared by: Lily Rev.: A Checked by: Tom Date: 2018-07-13 Approved by: Wangxiaojun

#### **Optical Characteristic Curves (Yellow Green)**



Part No.: S2012CHRYGBT-001 Prepared by: Lily Rev.: A Checked by: Tom Date: 2018-07-13 Approved by: Wangxiaojun

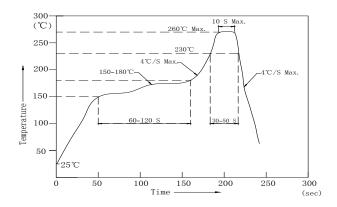
#### **Optical Characteristic Curves (Blue)**



Rev.: A Checked by: Tom

## **Reflow Profile**

■ Reflow Temp/Time



## Notes:

- 1. We recommend the reflow temperature 245  $^\circ C$  (±5  $^\circ C$ ).the maximum soldering temperature should be limited to 260  $^\circ C$ .
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

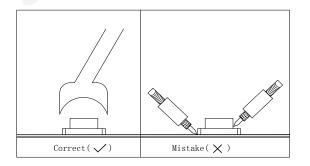
## ■Soldering iron

Basic spec is ≤ 5sec when  $320^{\circ}$ C (± $20^{\circ}$ C). If temperature is higher, time should be shorter (+ $10^{\circ}$ C → -1sec).

Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under  $350^{\circ}$ C.

#### Rework

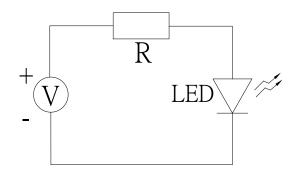
- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

#### Test circuit and handling precautions

Test circuit



#### Handling precautions

## 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

## 2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

- 2.2 Shelf life in sealed bag: 12 month at  $<5^{\circ}C^{\sim}30^{\circ}C$  and <30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at  $\leq$  20 R.H. with zip-lock sealed.
- 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- 3.1 60±3°C x(12~24hrs) and <5%RH, taped reel type
- 3.2 100±3°C x (45min~1hr), bulk type
- 3.3 130±3°C x (15~30min), bulk type

# Test Items and Results of Reliability

Test Item	Test Conditions	est Conditions Test Method		Number of Test
Reflow Soldering	Ta=260±5 ℃,Time=10±2S	ime=10±2S JB/T 10845-2008		0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5℃ 30±1min 个→(25℃/5±1min)↓ 100±5℃ 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5℃ $\sim$ 100±5℃, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5℃~65±5℃, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH GB/T 2423.3-2006		1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH~55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5℃,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

# Forward Voltage Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit
Red		1.8	2.4	
Yellow Green		1.8	2.4	
	f	2.8	3.1	V
Blue	g	3.1	3.4	
	h	3.4	3.7	

# Luminous Intensity Rank Combination (IF=20mA)

Ran	k	Min.	Max.	Unit
	J	100	125	
	к	125	160	
	L	160	200	
Red	Μ	200	250	
	Ν	250	320	
	0	320		
	D	25	32	
	E	32	40	mcd
Yellow Green	F	40	50	
	G	50	63	
	н	63		
	J	100	125	
	к	125	160	
Blue	L	160	200	
	М	200	250	
	Ν	250		

## Dominant wavelength Rank Combination (IF=20mA)

Rank		Min.	Max.	Unit
Red	t	620	625	
Keu	u	625	630	
	h	565	568	
Yellow Green	i	568	572	
	j	572	576	nm
	G	465	467.5	
Dhue	н	467.5	470	
Blue		470	472.5	
	J	472.5	475	

# Group Name on Label (Example DATA: 🗆 Lt 🗆 Ej gJG 20)

DATA: □Lt □Ej gJG 20		Vf(V)	lv (mcd)	λd (nm)	Test Condition
Red	□→L→t→20	1.8~2.4	160~200	620~625	
Yellow Green	□→E→j→20	1.8~2.4	32-40	572~576	IF=20mA
Blue	g→J→G→20	3.1~3.4	100~125	465~467.5	

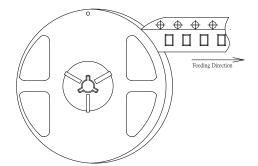
Notes:

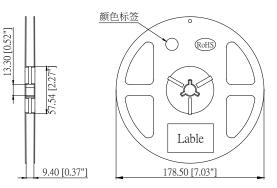
- 1.The tolerance of luminous intensity (Iv )is  $\pm 15~\%$  .
- 2. The tolerance of dominant wavelength is  $\pm$  1nm.
- 3. This specification is preliminary.
- 4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

#### 2012 Series SMD Chip LED Lamps Packaging Specifications

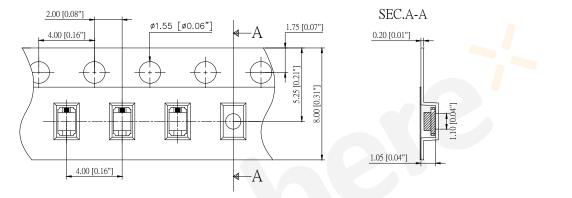
• Feeding Direction

• Dimensions of Reel (Unit: mm)

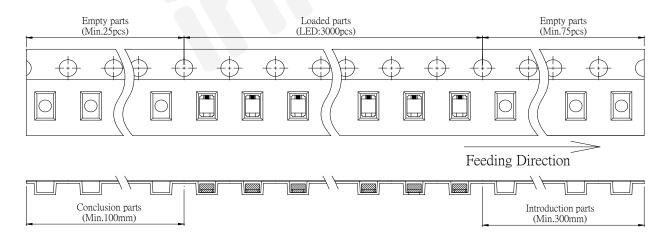




• Dimensions of Tape (Unit: mm)



# • Arrangement of Tape

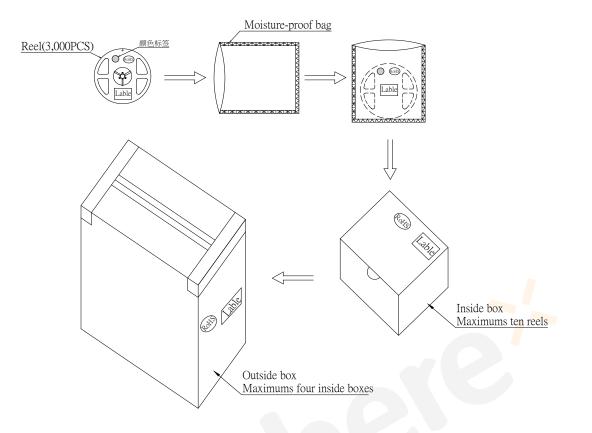


## Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 3,000pcs/Reel.

#### 2012 Series SMD Chip LED Lamps Packaging Specifications

## • Packaging specifications



Notes:

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 30,000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.